U.S. Department of Commerce

(Rev. 6-93) OMB No. 0651-0011 (exp. 4/94)	102157607	Patent And Trademark Office	
To the Honorable Commissioner of Patents an		original document or copy thereof.	
Name of conveying party(ies):	7-9-02	Name and address of receiving party(ies):	
Jeffrey D CHINN Yi-Hsing CHEN Robert Z BACHRACH John Christopher MORAN	Date 03-06-02 04-17-02 03-18-02 03-05-02	Name: APPLIED MATERIALS, INC Internal Address: PATENT COUNSEL, M/S 2061 Street Address: P.O. Box 450-A City: Santa Clara State: CA Zip: 95052	
Additional name(s) of conveying Yes X No	party(ies) attached?	Additional name(s) & address(es) attached? Yes _X_ No	
3. Nature of conveyance: X Assignment	Merger	FINANCE	
Security Agreement	Change of Name	NANCE -0	
Other			
Execution Date: SEE ABOVE		SEC. M. C.	
Execution Date: SEE ABOVE 4. Application number(s) or registration number(s): 2. 2. 3. 3. 3. 3. 3. 3. 3. 3. 3. 3. 3. 3. 3.			
A. Patent Application No.(s)			
B. Patent No.(s)			
Additional numbers attached?	Yes X No		
		6. Total number of applications and patents involved:1	
Name and address of party to whom corres document should be mailed:	spondence concerning	7. Total fee (37 C.F.R. 3.41)	
Name: APPLIED MATERIALS, I	<u>NC</u>	X Authorized to be charged to deposit account	
Internal Address: PATENT COUNSEL,	M/S 2061	50-1074	
Street Address: P.O. Box 450-A		8. Deposit account number: 50-1074	
City: <u>Santa Clara</u> State: <u>CA</u>	Zip: <u>95052</u>		
	DO NOT HER	THIS SPACE	
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Joseph Bach Registration No. 37, 771 Name of Person Signing Total number of pages including cover sheet, attachments and document: 9			
	Mail documents to be recorded with	required cover sheet information to:	

Washington, D.C. 20231

FORM PTO-1595

10074277

01 FC:581

MS\272 (AUGUST 20, 1993)

PATENT

REEL: 013078 FRAME: 0521

Attorney Docket No.: AM-5418

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1) Jeffrey D. Chinn

2) Yi-Hsing Chen

3) Robert Z. Bachrach

4) John Christopher Moran

(hereinafter referred to as Assignors), have invented a certain invention entitled:

USE OF INTEGRATED POLYGEN DEPOSITION AND RTP FOR MICROELECTROMECHANICAL SYSTEMS

for which an application for Letters Patent in the United States was filed on <u>February 11, 2002</u>, <u>under Serial No. 10/074,277</u>; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for

-1-

PATENT

U.S. Express Mail No.:	US	
Attorne	v Docket No - AM 5418	

interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the date indicated below.

1)	3/6/02	Jeffrey D. Whinn
2)		, 2002 Yi-Hsing Chen
3)	 	, 2002 Robert Z. Bachrach
4)	·	, 2002 John Christopher Moran

US

Attorney Docket No.: AM-5418

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1) Jeffrey D. Chinn

2) Yi-Hsing Chen

3) Robert Z. Bachrach

4) John Christopher Moran

(hereinafter referred to as Assignors), have invented a certain invention entitled:

USE OF INTEGRATED POLYGEN DEPOSITION AND RTP FOR MICROELECTROMECHANICAL SYSTEMS

for which an application for Letters Patent in the United States was filed on <u>February 11, 2002</u>, under Serial No. 10/074,277; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for

PATENT REEL: 013078 FRAME: 0524

U.S.	Express	Mail No .:	

-U

Attorney Docket No.: AM-5418

interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the date indicated below.

1)	, 2002	
,	Jeffrey D. Chinn	

2)	April 12th, 2002	Villing	Olon
,		i-Hgsing Chen	
		I-riping Officia	

3)	, 2002
	Robert 7 Bachrach

4)	, 2002
,	John Christopher Moran

Attorney Docket No.: AM-5418

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1) Jeffrey D. Chinn

- 2) Yi-Hsing Chen
- 3) Robert Z. Bachrach
- 4) John Christopher Moran

(hereinafter referred to as Assignors), have invented a certain invention entitled:

USE OF INTEGRATED POLYGEN DEPOSITION AND RTP FOR MICROELECTROMECHANICAL SYSTEMS

for which an application for Letters Patent in the United States was filed on <u>February 11, 2002</u>, under Serial No. 10/074,277; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for

-1-

		U.S. Express Mail N	o.: US
		Atto	rney Docket No.: AM-5418
nterference c	r other priority proceedings inv	olving said Invention; and	(f) for legal proceedings
vithout limitat proceedings,	Invention and any application to ion opposition proceedings, car infringement actions and could id Assignors in providing such c	ncellation proceedings, pri rt actions; provided, how	ority contests, public use vever, that the expense
3.	The term and covenants of		

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the date indicated below.

1)	, 2002
	Jeffrey D. Chinn
2)	, 2002
,	Yi-Hsing Chen
3)	3/18/2002, 2002 Rhand 3 Bachnach Robert Z. Bachrach
. ,	Robert Z. Bachrach
4)	, 2002
•,	John Christopher Moran

all No.: US
Attorney Docket No.: AM-5418

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses of Inventors:

1) Jeffrey D. Chinn

2) Yi-Hsing Chen

3) Robert Z. Bachrach

4) John Christopher Moran

(hereinafter referred to as Assignors), have invented a certain invention entitled:

USE OF INTEGRATED POLYGEN DEPOSITION AND RTP FOR MICROELECTROMECHANICAL SYSTEMS

for which an application for Letters Patent in the United States was filed on <u>February 11, 2002</u>, under Serial No. 10/074,277; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as the Application), and the invention disclosed therein (hereinafter referred to as the Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as the Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

- 1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.
- 2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for

-1-

US

Attorney Docket No.: AM-5418

interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefor and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

- 3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.
- 4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the date indicated below.

1)	, 2002
•	Jeffrey D. Chinn

2)	, 2002
•	Yi-Hsing Chen

3)	, 2002	
,	Robert Z. Bachrach	

4)	3/5	, 2002	John	Deuts	(1)	Marian	
ŕ		Johr	Christopher	Moran	/		
			V	()		

RECORDED: 07/09/2002